### DATASHEET - CI23E-125-RAL7032



### Insulated enclosure, +knockouts, RAL7032, HxWxD=250x187.5x150mm



1/5

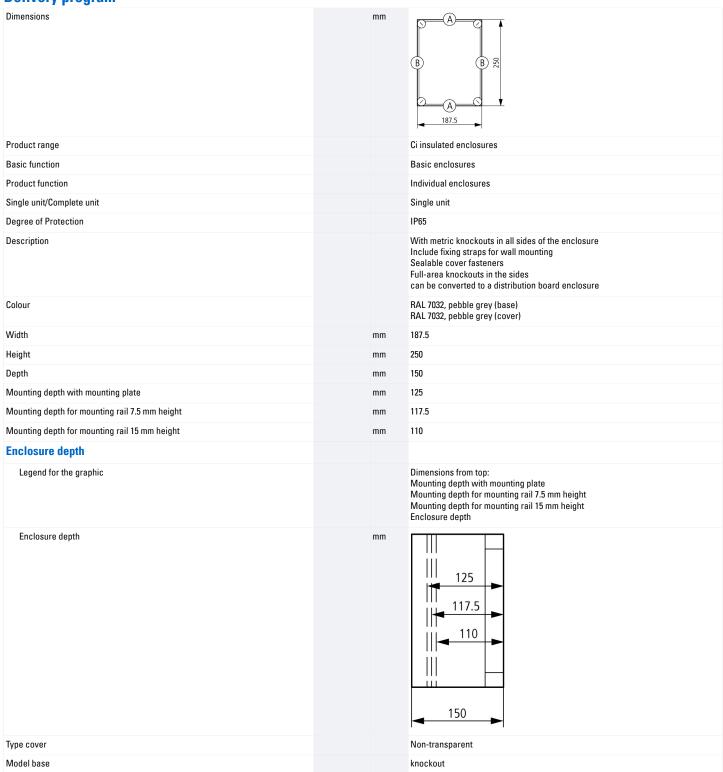
Part no. CI23E-125-RAL7032

Catalog No. 090152

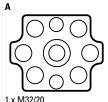
EL-Nummer (Norway)

2502331

### **Delivery program**



### Notes



6 x M20 2 x M16 **B** 

2 x M32/20

4 x M25/16

4 x M20

4 x M16

Technical data General		
Standards		IEC/EN 60529 EN 50262 DIN 43656 DIN 43660 EN 60439-4 for ClX individual enclosures with combined distribution boards from Ci enclosures up to 680 A. Can thus be used for socket combinations and as component for construction site distribution boards.
Climatic proofing		Damp heat, constant, to IEC 60068-2-78 Damp heat, cyclic, to IEC 60068-2-30
Ambient temperature	°C	-40 - +80
Degree of Protection		IP65
Power loss		
Max. radiated heat dissipation with separate mounting, ambient air temperature +20 $^{\circ}\text{C}$	W	33
Max. radiated heat dissipation in distribution board combination to VDE 0660 $$ Part 500 $$	W	25
Notes		When calculating the heat dissipation, the quadratic relationship of current with the rated diversity factor a must be considered. $P_v = I_2  x  R$ $P_v' = P_v  x  a^2$ If no data is available concerning the load relationships of the individual circuits, the rated diversity factor is selected conform to VDE 0660 Part 500.
additional technical data for UL-/CSA- approved devices		see UL-report File No. E54120
Operating and ambient conditions to VDE 0660 Part 500		
Colour		
Base		RAL 7035, light gray
Housing body		Transparent, smoky gray RAL 7035, light gray
Material characteristics		
Material		glass-fibre reinforced polycarbonate (base) non-reinforced polycarbonate (cover) Halogen free
Surface treatment		Resistant to corrosion
Colour		RAL 7032, pebble grey (base) RAL 7032, pebble grey (cover)
Colour		
Base		RAL 7035, light gray

Housing body		Transparent, smoky gray RAL 7035, light gray
Material properties		
Electrical		
Track resistance		KB160, KC175 (base, to IEC 60112) KB100, KC200 (cover, to IEC 60112)
Surface resistance to IEC 60093	$\Omega \times 10^{13}$	1
Dielectric strength to IEC 60243-1	kV/mm	30
Thermal		
Temperature resistant		-40 °C - 120 °C (enclosure) 85 °C (enclosure bolt) 80 °C (gasket)
Mechanical		
Impact resistance		IK10 according to EN 50102
Loading capacity	kg/m <sup>2</sup>	5
Chemical resistance		

Chemical resistant		Resistant against: Acids < 10 %, mineral oil, alcohol, gasoline, greases, salt solutions Partly resistant to: Acids > 10 % Not resistant to: alkalis, benzene
Atmospheric		
Saline spray		IEC 60068-2-11
UV resistance		Beneath protective shield
Water consumption to DIN EN ISO 62	%	0.29
Flammability characteristics		
Flammability classification according to UL94		V1 (base) V2 (cover)

# Design verification as per IEC/EN 61439

and fire due to internal electric effects  10.2.4 Resistance to ultra-violet (UV) radiation  10.2.5 Lifting  5 kg per enclosure with support frame and lifting aid met; assembled and sect as per the latest applicable instruction leaflet.  10.2.6 Mechanical impact  10.2.7 Inscriptions  Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  The panel builder's responsibility.  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  10 the panel builder's responsibility.	besign vermoution as per 120/214 01405			
of the enclosure, calculated as per IEC 60890  Individual enclosure for wall mounting Py CO 11  Starting enclosure for wall mounting Py CO 10  Heat dissipation, at an ambient temperature of 35°C, deflat 1:35 degrees in top of the enclosure, calculated as per IEC 60890  Individual enclosure for wall mounting Py CO 24  Starting enclosure for wall mounting Py CO 25  Individual enclosure for wall mounting Py CO 26  Starting enclosure for wall mounting Py CO 27  Starting enclosure for wall mounting Py CO 26  Individual enclosure for wall mounting Py CO 27  IEC/EN 61:39 design verification ID2.2 Strength of materials and parts ID2.2 Corrosion resistance of mailating materials to a bonomal heat ID2.31 Verification of thermal stability of enclosures ID2.32 Verification of resistance of insulating materials to abnormal heat ID2.33 Verification of resistance of insulating materials to abnormal heat ID2.34 Verification of existance of insulating materials to abnormal heat ID2.54 Interriptions ID2.54 Interriptions ID2.55 Lifting ID2.56 Mechanical impact ID2.56 Mechanical impact ID2.57 Interriptions ID2.58 Interpretation of ASSEMBLIES ID3 Degree of protection of ASSEMBLIES ID3 Degree of protection of ASSEMBLIES ID3 Degree of protection of advicting devices and components ID3 Degree of protection of advicting devices and components ID3 Internal electrical circuits and connecctions ID4 Internal electrical circuits and connecctions ID4 Internal electrical circuits and connecctions ID5 In	Technical data for design verification			
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Heat dissipation, at an ambient temperature of 35°C, delta T. 35 degrees in top of the enclosure, calculated as per IEC 0890°C, delta T. 35 degrees in top of the enclosure, calculated as per IEC 0890°C, delta T. 35 degrees in top of the enclosure for wall mounting  Py CO 24  Starting enclosure for wall mounting Py CO 25  Biddle enclosure for wall mounting Py CO 26  BEC/EN 61439 design verification  10.2 Strength of materials and parts 10.2.2 Corrosion resistance 10.2.1 Verification of thermal stability of enclosures 10.2.3 Verification of resistance of insulating materials to normal heat and fire due to internal electric effects 10.2.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects 10.2.4 Expension of the second of the second part of the	Starting enclosure for wall mounting	$P_V$	CO	11
of the enclosure, calculated as per IEC 68890 Individual enclosure for wall mounting Py CO 24 Starting enclosure for wall mounting Py CO 25 Whide enclosure for wall mounting Py CO 26  IECCEN 61439 design verification 10.2 Strength of materials and parts 10.2.2 Corrosion resistance 10.2.3.1 Verification of thermal stability of enclosures 10.2.3.2 Verification of thermal stability of enclosures 10.2.3.2 Verification of resistance of insulating materials to normal heat and fire due to internal electric effects 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Litting 10.2.5 Litting 10.2.5 Mechanical impact 10.2.5 Mechanical impact 10.2.5 Deprecation of ASSEMBLIES 10.4 Clearrances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation orporateises 10.9 Protection signate electric strength 10.9 Insulation or properties 10.9 Protection signate electric strength 10.9 Insulation or properties 10.9 Protection signate electric strength 10.9 Insulation or properties 10.9 Protection signate electric strength 10.9 Insulation or properties 10.9 Protection signate electric strength 10.9 Insulation or properties 10.9 Protection signate electric strength 10.9 Insulation or properties 10.9 Protection class 2, therefore not applicable. 10.9 Insulation or properties 10.9 Protection class 2, therefore not applicable. 10.9 Insulation or properties 10.9 Protection class 2 the report of external conductors 10.9 Insulation or properties 10.9 Protection class 2 the report of external conductors 10.9 Insulation or properties 10.9 Protection class 2 therefore not applicable. 10.9 Insulation of the external conductors 10.9 Insulation of the external conduct	Middle enclosure for wall mounting	$P_V$	CO	10
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Middle enclosure for wall mounting Pv CO 20  IEC/EN 61439 design verification  10.2 Strength of materials and parts  10.2.2 Corrosion resistance  10.2.3.1 Verification of thermal stability of enclosures  10.2.3.2 Verification of resistance of insulating materials to normal heat  10.2.3.2 Verification of resistance of insulating materials to abnormal heat  10.2.3.3 Verification of resistance of insulating materials to abnormal heat  10.2.4 Resistance to ultra-violet (UV) radiation  10.2.5 Lifting  10.2.6 Mechanical impact  10.3.0 Expression of ASSEMBLIES  10.4.1 Clearances and creepage distances  10.5 Protection against electric shock  10.5 Protection of switching devices and components  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.1 Power-frequency electric strength  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9 Insulation properties  10.10 Temperature rise  10.11 Short-circuit rating  10.10 Temperature rise  10.12 Electromagnetic compatibility  10.15 Lelectromagnetic compatibility  10.16 Electromagnetic compatibility  10.17 Electromagnetic compatibility  10.18 Lelectromagnetic compatibility  10.19 Electromagnetic compatibility  10.10 Temperature rise	Individual enclosure for wall mounting	$P_{V}$	CO	24
IEC/EN 61439 design verification  10.2 Strength of materials and parts  10.2.2 Corrosion resistance  10.2.3.1 Verification of thermal stability of enclosures  10.2.3.2 Verification of resistance of insulating materials to normal heat  10.2.3.2 Verification of resistance of insulating materials to abnormal heat  10.2.3.1 Verification of resistance of insulating materials to abnormal heat  10.2.3.1 Verification of resistance of insulating materials to abnormal heat  10.2.4 Resistance to ultra-violet (UV) radiation  10.2.5 Lifting  10.2.5 Lifting  10.2.6 Mechanical impact  10.2.7 Inscriptions  10.3.1 Degree of protection of ASSEMBLIES  10.4.1 Clearances and creepage distances  10.4.2 Clearances and creepage distances  10.5 Protection against electric shock  10.5 Inscription of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.1 Protection properties  10.9.2 Power-frequency electric strength  10.9 Insulation properties  10.9.3 Impulse withstand voltage  10.10 Temperature rise  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  10.15 Electromagnetic compatibility  10.16 Electromagnetic compatibility  10.17 Electromagnetic compatibility  10.18 Electromagnetic compatibility  10.19 Is the panel builder's responsibility.  10.19 Is the panel builder's responsibility.	Starting enclosure for wall mounting	$P_{V}$	CO	22
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10.2.2 Corrosion resistance 10.2.3.1 Verification of thermal stability of enclosures Meets the product standard's requirements. 10.2.3.2 Verification of resistance of insulating materials to normal heat 10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Lifting Sk per enclosure with support frame and lifting aid met; assembled and secials as per the latest applicable instruction leaflet. 10.2.6 Mechanical impact 10.2.7 Inscriptions Meets the product standard's requirements 10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock Protection against electric shock Protection against electric shock 10.5 Incorporation of switching devices and components 10.5 Incorporation of switching devices and components 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength U, = 1000 V AC 10.9.3 Impulse withstand voltage 8 kV 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise The panel builder's responsibility. 10 Internal electric accounts and connections 10.10 Temperature rise The panel builder's responsibility. 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 11.15 Short-circuit rating 11.15 Nort-circuit rating 11.15 Life to the temperature rise calculation. Eaton we provide heat dissipation data for the devices. 11.15 Nort-circuit rating	IEC/EN 61439 design verification			
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10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects  10.2.4 Resistance to ultra-violet (UV) radiation  10.2.5 Lifting  Sk per enclosure with support frame and lifting aid met; assembled and sect as per the latest applicable instruction leaflet.  10.2.6 Mechanical impact  10.2.7 Inscriptions  Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Power-frequency electric strength  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  1s the panel builder's responsibility.	10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
and fire due to internal electric effects  10.2.4 Resistance to ultra-violet (UV) radiation  10.2.5 Lifting  5 kg per enclosure with support frame and lifting aid met; assembled and sect as per the latest applicable instruction leaflet.  10.2.6 Mechanical impact  10.2.7 Inscriptions  Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  The panel builder's responsibility.  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  10 the panel builder's responsibility.	10.2.3.2 Verification of resistance of insulating materials to normal heat			Meets the product standard's requirements.
10.2.5 Lifting  5 kg per enclosure with support frame and lifting aid met; assembled and sect as per the latest applicable instruction leaflet.  10.2.6 Mechanical impact  10.2.7 Inscriptions  Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  The panel builder is responsibility.  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  15 kg per enclosures with stand lifting aid met; assembled and sect as per the latest applicable instruction leaflet.  IK10  IK10  IK10  IK10  IK10  IK10  IM20				Lower part: 960 °C / cover: 850 °C; meets the product standard's requirements.
as per the latest applicable instruction leaflet.  10.2.6 Mechanical impact  10.2.7 Inscriptions  Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  10.12 Electromagnetic compatibility  10.12 Electromagnetic compatibility  10.14 Espanel builder's responsibility.  10.16 Incorporation of switching devices and components  11.10 Temperature rise  12.10 Temperature rise  13.10 Temperature rise  14.11 Short-circuit rating  15.12 Electromagnetic compatibility  16.15 Electromagnetic compatibility  17.16 Temperature rise seponsibility.  18.17 In Early Builder's responsibility.  19.19 Electromagnetic compatibility  19.10 Temperature rise seponsibility.	10.2.4 Resistance to ultra-violet (UV) radiation			Not relevant to indoor installations.
10.2.7 Inscriptions  Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  Is the panel builder's responsibility.  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.  Is the panel builder is responsibility.  Is the panel builder is responsibility.  Is the panel builder is responsibility.	10.2.5 Lifting			$5\mathrm{kg}$ per enclosure with support frame and lifting aid met; assembled and secured as per the latest applicable instruction leaflet.
10.3 Degree of protection of ASSEMBLIES  10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.  Is the panel builder's responsibility.  Is the panel builder is responsibility.  Is the panel builder is responsibility.  Is the panel builder is responsibility.  Is the panel builder's responsibility.	10.2.6 Mechanical impact			IK10
10.4 Clearances and creepage distances  10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.	10.2.7 Inscriptions			Meets the product standard's requirements.
10.5 Protection against electric shock  10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  8 kV  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  Protection class 2, therefore not applicable.  Is the panel builder's responsibility.  Is the panel builder's responsibility.  Protection class 2, therefore not applicable.  Is the panel builder's responsibility.  Protection class 2, therefore not applicable.  Is the panel builder's responsibility.	10.3 Degree of protection of ASSEMBLIES			IP65
10.6 Incorporation of switching devices and components  10.7 Internal electrical circuits and connections  10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.10 Short-circuit rating  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.  Is the panel builder's responsibility.  Is the panel builder is responsibility.  Is the panel builder's responsibility.  Is the panel builder's responsibility.	10.4 Clearances and creepage distances			Is the panel builder's responsibility.
10.7 Internal electrical circuits and connections  Is the panel builder's responsibility.  10.8 Connections for external conductors  Is the panel builder's responsibility.  10.9 Insulation properties  10.9.2 Power-frequency electric strength  U <sub>i</sub> = 1000 V AC  10.9.3 Impulse withstand voltage  8 kV  10.9.4 Testing of enclosures made of insulating material  Meets the product standard's requirements.  10.10 Temperature rise  The panel builder is responsible for the temperature rise calculation. Eaton we provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  Is the panel builder's responsibility.	10.5 Protection against electric shock			Protection class 2, therefore not applicable.
10.8 Connections for external conductors  10.9 Insulation properties  10.9.2 Power-frequency electric strength  10.9.3 Impulse withstand voltage  8 kV  10.9.4 Testing of enclosures made of insulating material  10.10 Temperature rise  10.11 Short-circuit rating  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.  Is the panel builder's responsibility.	10.6 Incorporation of switching devices and components			Is the panel builder's responsibility.
10.9 Insulation properties  10.9.2 Power-frequency electric strength  U <sub>i</sub> = 1000 V AC  10.9.3 Impulse withstand voltage  8 kV  10.9.4 Testing of enclosures made of insulating material  Meets the product standard's requirements.  The panel builder is responsible for the temperature rise calculation. Eaton w provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  10.12 Electromagnetic compatibility	10.7 Internal electrical circuits and connections			Is the panel builder's responsibility.
10.9.2 Power-frequency electric strength  U <sub>i</sub> = 1000 V AC  10.9.3 Impulse withstand voltage  8 kV  10.9.4 Testing of enclosures made of insulating material  Meets the product standard's requirements.  The panel builder is responsible for the temperature rise calculation. Eaton w provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  10.12 Electromagnetic compatibility	10.8 Connections for external conductors			Is the panel builder's responsibility.
10.9.3 Impulse withstand voltage  8 kV  10.9.4 Testing of enclosures made of insulating material  Meets the product standard's requirements.  The panel builder is responsible for the temperature rise calculation. Eaton w provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  10.12 Electromagnetic compatibility	10.9 Insulation properties			
10.9.4 Testing of enclosures made of insulating material  Meets the product standard's requirements.  The panel builder is responsible for the temperature rise calculation. Eaton w provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.	10.9.2 Power-frequency electric strength			$U_i = 1000 \text{ V AC}$
10.10 Temperature rise  The panel builder is responsible for the temperature rise calculation. Eaton w provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.	10.9.3 Impulse withstand voltage			8 kV
provide heat dissipation data for the devices.  10.11 Short-circuit rating  Is the panel builder's responsibility.  10.12 Electromagnetic compatibility  Is the panel builder's responsibility.	10.9.4 Testing of enclosures made of insulating material			Meets the product standard's requirements.
10.12 Electromagnetic compatibility  Is the panel builder's responsibility.	10.10 Temperature rise			The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices.
	10.11 Short-circuit rating			Is the panel builder's responsibility.
10.12 Machanical function	10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
10.13 Meetranical function	10.13 Mechanical function			Meets the product standard's requirements.

## Technical data ETIM 6.0

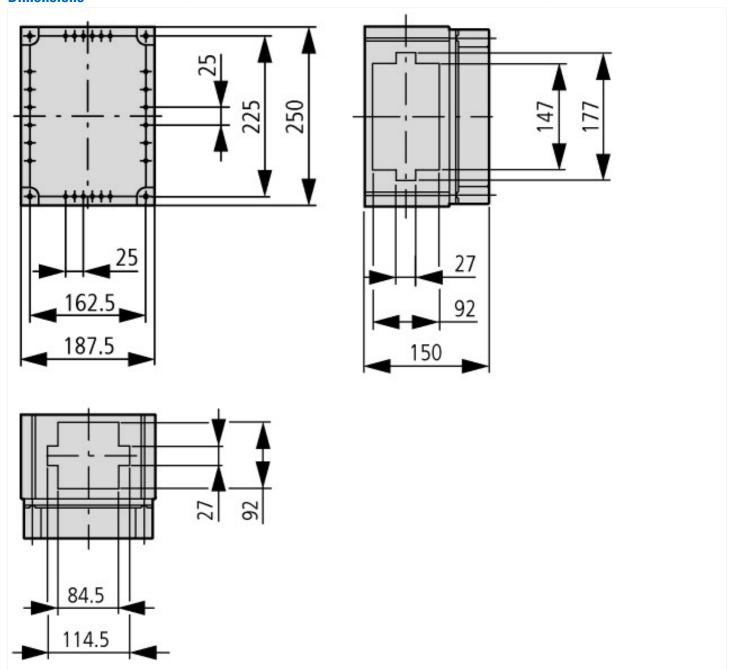
Distribution boards (EG000023) / Empty cabinet (EC00	00058)
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Electric engineering, automation, process control engineering / Electrical installation, device / Electrical distribution system (incl. small distribution board) / Empty cabinet (small distribution board) (ecl@ss8.1-27-14-24-08 [ACN385008])

55414/ (551-5555.1 27 17 27 55 [71511555555])	
Mounting method	Surface mounted (plaster)
Type of cover	Optional
Cover model	Closed

Type of door		None
Transparent cover/door		No
With lock		No
Rated current (In)	Α	1600
Height	mm	250
Width	mm	187.5
Depth	mm	150
Built-in depth	mm	125
Internal depth	mm	125
Plate thickness cabinet	mm	6
Plate thickness door/cover	mm	6
RAL-number		7032
Number of modules		1
Number of rows		0
Width in number of modular spacings		9
Number of openings for flange plates		4
Extension possible		Yes
Number of conduit inlets		30
Material housing		Plastic
Surface protection		Other
With mounting plate		No
Suitable for outdoor use		Yes
Suitable for lightning protection		Yes
Degree of protection (IP)		IP65
Protection class		II
Impact strength		IK10
Circuit integrity		Other

## **Dimensions**



# **Additional product information (links)**

Manufacturer's Declaration CI-RoHS	ftp://ftp.moeller.net/DOCUMENTATION/PDF/2013-01-31_Ci_RoHS.pdf
Declaration of conformity	ftp://ftp.moeller.net/DOCUMENTATION/PDF/ci_ce.pdf